	BLE STAN	IDARD							
	OPERATING TEMPERATUR	RE RANGE	-40°C TO + 85°C(NOTE	1) RANG	E	MPERATURE	-10°C T0 + 60°C	(NOTE 3)	1
	OPERATING HUMIDITY RA	NGE	40% T0 + 80% (NOTE	2) STOR	AGE DITY RAN	GE	40% TO + 70% (N	OTF 3)	
	VOLTAGE	NOL	250V AC/DC			ONNECTOR	DF11-**DS-2C		
	CURRENT		AWG24 : 2.5A	APPLI	CABLE C	ABLE	0111 000 20	(1117)	
			AWG26 : 2.0A				UL1061,1007 AWG24 TO 28		
			AWG28 : 1.0A						
				IFICATIO	<u>DNS</u>				_
			TEST METHOD			REQ	UIREMENTS	QT	A
SENERAL EX			AND BY MEASURING INSTRU					V	Τ,
			ED VISUALLY.				wind.	X	
-	IC CHARA							~	
CONTACT RE			DC OR 1000 Hz).		30mΩ	MAX.		V	Т
			<u> </u>					X	
	NICAL CH								
MECHANICAL	OPERATION	50 TIMES	INSERTIONS AND EXTRACTIONS	ONS.	-		TANCE: 30mΩ MAX. ACK OR LOOSENESS OF		
					-	RTS.		Х	-
		□0.5±0.002 BY STEEL GAUGE.			INSERTION FORCE 4.4N MAX EXTRACTION FORCE 0.3N MIN				
AND EXTRACTION FORCE VIBRATION SHOCK		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE						X	+-
		0.75 mm, AT 2 h, FOR 3 DIRECTIONS.			<u> </u>	 NO ELECTRICAL DISCONTINUITY OF 1μs. NO DAMAGE, CRACK OR LOOSENESS OF 			-
						RTS.			_
		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOP DIRECTIONS.			-		DISCONTINUITY OF 1µs. ACK OR LOOSENESS OF	Х	
			<u>^</u>		PAF	RTS.			
			ACTERISTICS 🖉		-				
RAPID CHANGE OF		TEMPERATURE $-55 \rightarrow 5$ TO $35 \rightarrow 85 \rightarrow 5$ TO $35 \circ C$			(1) CONTACT RESISTANCE: $30m\Omega$ MAX.				
		TIME	$30 \rightarrow 10 \text{ TO} 15 \rightarrow 30 \rightarrow 10 \text{ T}$	- 0 15 min	2 NO	DAMAGE CR.		X	
RAPID CHAN		TIME UNDER 5	30→10 TO 15→30→10 T CYCLES.	O 15 min	-	DAMAGE, CRA RTS.	ACK OR LOOSENESS OF	X	-
TEMPERATU	RE	UNDER 5			PAF ① CON	RTS. NTACT RESIS	TANCE: 30mΩ MAX.		-
TEMPERATUI DAMP HEAT STEADY STA REMARKS NOTE 1:INCLI NOTE 2:NO C NOTE 3:APPL	RE ATE) UDING THE TEI CONDENSING. LY TO THE CON	UNDER 5 EXPOSED MPERATURI	CYCLES. AT 40 ± 2 °C, 90 TO 95 %, 96 E RISE BY CURRENT LONG TERM STORAGE FOR U	Sh.	PAF ① COM ② NO PAF CTS BEF(RTS. NTACT RESIS DAMAGE, CRA RTS. DRE MOUNTE	TANCE: 30mΩ MAX. ACK OR LOOSENESS OF	x	-
TEMPERATUI DAMP HEAT STEADY STA REMARKS NOTE 1:INCLI NOTE 2:NO C NOTE 3:APPL AFTE	RE ATE) UDING THE TEI CONDENSING. LY TO THE CON	UNDER 5 EXPOSED MPERATURI IDITION OF I DN PCB, OPE	CYCLES. AT 40 ± 2 °C, 90 TO 95 %, 96 E RISE BY CURRENT LONG TERM STORAGE FOR U ERATION TEMPERATURE AND	Sh.	PAF ① COM ② NO PAF CTS BEF(RTS. NTACT RESIS DAMAGE, CRA RTS. DRE MOUNTE	TANCE: 30mΩ MAX. ACK OR LOOSENESS OF		
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